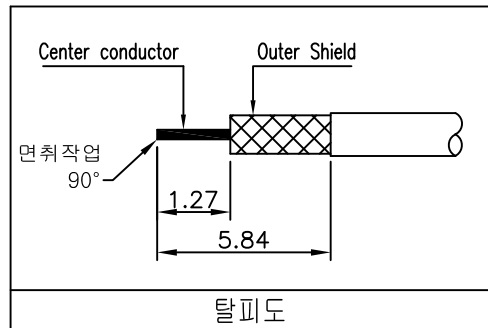
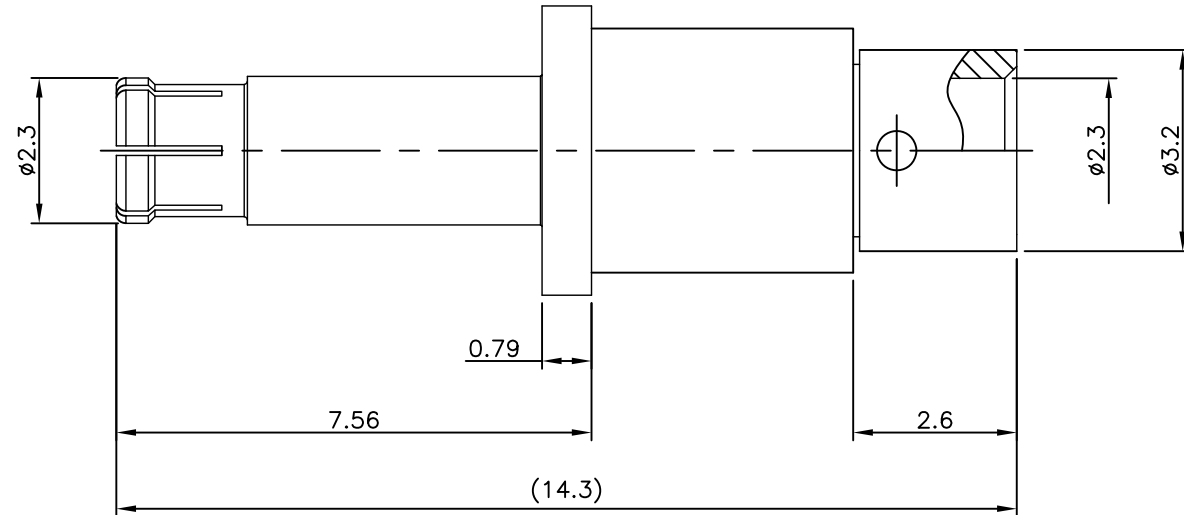
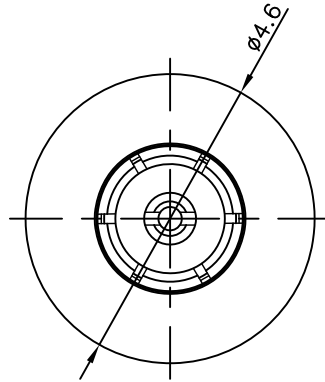


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1R	Initial Registration	S.H.KIM		2024.07.19.



5	INSULATOR	1	TEFLON		DIN03403-N/2
4	INSULATOR	1	TEFLON		DIN03403-N/1
3	CONTACT	1	BeCu C17300	Gold Plate (1.27μm)	DCT04442-5/1
2	BODY	1	MBsBD C3604BD-F	Gold Plate (1.27μm)	DBD04954-5/1
1	BODY	1	BeCu C17300	Gold Plate(무광) (1.27μm)	DBD04953-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2024. 07. 19.			 KJ COMTECH CO.,LTD. RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY			
MATERIAL _____	CHECKED BY	TITLE SMPM50 CABLE JS 85			
	DRAWN BY				S.H.KIM
FINISH _____	SCALE 8/1	UNIT mm		A4	DWG NO. CN04141-7/1
					REVISION I R